- 8-Bit Parallel-Out Storage Register Performs Serial-to-Parallel Conversion with Storage
- Asynchronous Parallel Clear
- Active High Decoder
- Enable/Disable Input Simplified Expansion
- Expandable for N-Bit Applications
- Four District Functional Modes
- Package Options Include Ceramic Chip Carriers and Flat Packages in Addition to Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

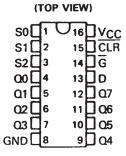
description

These 8-bit addressable latches are designed for general purpose storage applications in digital systems. Specific uses include working registers, serial-holding registers, and active-high decoders or demultiplexers. They are multifunctional devices capable of storing single-line data in eight addressable latches, and being a 1-of-8 decoder or demultiplexer with active-high outputs.

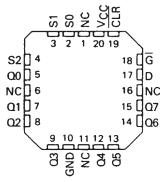
Four distinct modes of operation are selectable by controlling the clear (CLR) and enable (G) inputs as enumerated in the function table. In the addressable-latch mode, data at the data-in terminal is written into the addressed latch. The addressed latch will follow the data input with all unaddressed latches remaining in their previous states. In the memory mode, all latches remain in their previous states and are unaffected by the data or address inputs. To eliminate the possiblity of entering erroneous data in the latches, enable G should be held high (inactive) while the address lines are changing. In the 1-of-8 decoding or demultiplexing mode, the addressed output will follow the level of the D input with all other outputs low. In the clear mode, all outputs are low and unaffected by the address and data inputs.

The SN54259 and SN54LS259B are characterized for operation over the full military temperature range of -55°C to 125°C. The SN74259 and SN74LS259B are characterized for operation from 0°C to 70°C.

SN54259, SN54LS259B . . . J OR W PACKAGE SN74259 . . . N PACKAGE SN74LS259B . . . D OR N PACKAGE

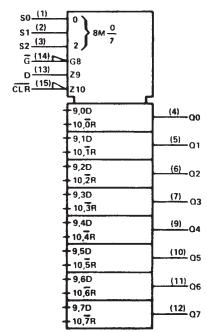


SN54LS259B . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

logic symbol†



[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.



FUNCTION TABLE

CLR	rs G	OUTPUT OF ADDRESSED LATCH	EACH OTHER OUTPUT	FUNCTION
н	L	D	Q _{iO}	Addressable Latch
н	Н	Q _{iO}	Q _{i0}	Memory
L	L	D	L	8-Line Demultiplexer
L	Н	L	L	Clear

 $\mathbf{H} \equiv \mathbf{high\ level},\, \mathbf{L} \equiv \mathbf{low\ level}$

LATCH SELECTION TABLE

SEL	ECT IN	IPUTS	LATCH
S2	S1	SO	ADDRESSED
L	L	L	0
L	L	H	1
L	Н	L	2
L	Н	H	3
н	L	L	4
Н	L	Н	5
Н	Н	L	6
Н	Н	н	7

schematic of inputs and outputs 259

EQUIVALENT OF EACH INPUT Vcc-Req INPUT $\overline{G}\colon \ R_{eq} = 2.2 \ k\Omega \ NOM$ All other inputs: $R_{eq} = 4 \ k\Omega \ NOM$

'259 TYPICAL OF ALL OUTPUTS 100 Ω NOM OUTPUT

'LS259B 'LS259B 'LS259B EQUIVALENT OF GINPUT **EQUIVALENT OF ALL OTHER INPUTS** TYPICAL OF ALL OUTPUTS - VCC 120 Ω NOM Vcc-VCC R_{eq} = 17 k Ω NOM $10 \text{ k}\Omega \text{ NOM}$ INPUT: INPUT: OUTPUT

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage (see Note 1)		 7 V
Input voltage: SN54259, SN74259.		 5.5 V
Operating free-air temperature range:	SN54259, SN54LS259B	 -55° C to 125° C
	SN74259, SN74LS259B	 \dots 0°C to 70°C
Storage temperature range		 -65° C to 150° C

NOTE 1: Voltage values are with respect to network ground terminal.



D ≡ the level at the data input

 $Q_{i0} \equiv$ the level of Q_i (i = 0, 1, . . . 7, as appropriate) before the indicated steady-state input conditions were established.

recommended operating conditions

		SN54	259	SN742	259	UNIT
	•	MIN NO	MIN NO	MIN NOM MAX		
Supply voltage, V _{CC}		4.5	5 5.5	4.75	5 5.25	V
High-level output current, IOH			-800		800	μΑ
Low-level output current, IOL			16		16	mA
Width of clear or enable pulse, tw		15		15		ns
	Data	15↑		151		
Setup time, t _{gU}	Address	5↑		5↑		ns
	Data	0↑		01		
Hold time, th	Address	20↑		20†		ns
Operating free-air temperature, TA		-55	125	0	70	°C

[†]The arrow indicates that the rising edge of the enable pulse is used for reference.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	DADAMETED		7567.00	NDITIONS†	S	N5425	9		N7425	9	UNIT
	PARAMETER		1EST CC	MUITIONS.	MIN	TYP‡	MAX	MIN	TYP‡	MAX	
ViH	High-level input voltag	je			2			2			V
VIL	Low-level input voltag	e					0.8			8.0	V
VIK	Input clamp voltage		V _{CC} = MIN,	I _I = 12 mA			-1.5			-1.5	V
Vон	High-level output volt	age	V _{CC} = MIN, V _{IL} = 0.8 V,	V _{IH} = 2 V, I _{OH} = -800 μA	2.4	3.4		2.4	3.4		V
VOL	Low-level output voltage		V _{CC} = MIN, V _{IL} = 0.8 V,	V _{IH} = 2 V, I _{OL} = 16 mA		0.2	0.4		0.2	0.4	v
l _l	Input current at maxis	num input voltage	V _{CC} = MAX,	V ₁ = 5.5 V			1			1	mA
ЧН	High-level input	G Other inputs	V _{CC} = MAX,	V ₁ = 2.4 V			80 40			80 40	μА
IIL	Low-level input	G Other inputs	V _{CC} = MAX,	V ₁ = 0.4 V			-3.2 -1.6			-3.2 -1.6	mA
los	Short-circuit output c		V _{CC} = MAX		-18		-57	-18		-57	mA
ICC	Supply current	·	V _{CC} = MAX,	See Note 2		60	90		60	90	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, VCC = 5 V, TA = 25°C

FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
CLR	Any Q			16	25	ns
S				14	24	ns
Data	Any u	Cլ = 15 pF,		11	20	7 "
		R _L = 400 Ω,		15	28	ns
Address	Any u	See Note 3		17	28	7 ''`
_		1		12	20	1
G	Any Q			11	20	ns
	(INPUT)	(INPUT) (OUTPUT) CLR Any Q Data Any Q Address Any Q	(INPUT) (OUTPUT) TEST CONDITIONS CLR Any Q Data Any Q CL = 15 pF, RL = 400 Ω, See Note 3	(INPUT) (OUTPUT) TEST CONDITIONS MIN CLR Any Q CL = 15 pF, Address Any Q RL = 400 Ω, See Note 3 See Note 3	(INPUT) (OUTPUT) TEST CONDITIONS MIN TYP CLR Any Q 16 Data Any Q 14 Address Any Q CL = 15 pF, RL = 400 Ω, See Note 3 15 See Note 3 17	(INPUT) (OUTPUT) TEST CONDITIONS MIN TYP MAX CLR Any Q 16 25 Data Any Q 14 24 CL = 15 pF, 11 20 RL = 400 Ω , 15 28 See Note 3 17 28 Image: Company C

t_{PLH} = propagation delay time, low-to-high-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $[\]ddagger$ All typical values are at $V_{CC} = 5 \text{ V}$, $T_{A} = 25^{\circ}\text{C}$.

[§] Not more than one output should be shorted at a time,

NOTE 2: $I_{\mbox{\footnotesize{CC}}}$ is measured with the inputs grounded and the outputs open.

tpHL = propagation delay time, high-to-low-level output

recommended operating conditions

			SI	154LS2	59B	SN	174LS25	59B	UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	UNII
Vcc	Supply voltage		4.5	5	5.5	4.75	5	5.25	٧
VIH	High-level input voltage		2			2			V
VIL	Low-level input voltage				0.7			0.8	V
ЮН	High-level output current				- 0.4			- 0.4	mA
IOL	Low-level output current				4			8	mA
	Pulse duration	G low	17			17			
tw	ruise duration	CLR low	10			10			, ris
		Data before G †	20			20			
t _{su}	Set up time	Address before G†	17			17			пѕ
		Address before G↓	0			0			
		Data after G t	0			0			
th	Hold time	Address after G †	0			0			ns
TA	Operating free-air temperature		- 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†						SN	UNIT		
FANAMETER		TEST COM	Dillons.		MIN	TYP	MAX	MIN	TYP	MAX	UNII
VIK	V _{CC} = MIN,	I _I = - 18 mA					1.5			- 1.5	V
V _{OH}	V _{CC} = MIN, I _{OH} = - 0.4 m	V _{IH} = 2 V, A	VIL = MAX,		2.5	3.4		2.7	3.4		٧
V	V _{CC} = MIN,	V _{IH} = 2 V,		IOL = 4 mA		0.25	0.4		0.25	0.4	v
VOL	VIL = MAX			IOL = 8 mA		_			0.35	0.5	ľ
l ₁	V _{CC} = MAX,	V _I = 7 V					0.1			0.1	mA
ЧН	V _{CC} = MAX,	V ₁ = 2.7 V					20			20	μА
HL	V _{CC} = MAX,	V _I = 0.4 V				-	- 0.4			- 0.4	mΑ
los§	V _{CC} = MAX				- 20		- 100	- 20		- 100	mA
¹ cc	V _{CC} = MAX,	See Note 2				27	36		22	36	mΑ

 $^{^\}dagger$ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	МІ	N TYP	MAX	UNIT
^t PHL	CLR	Any Q			12	18	ns
^t PLH	Data	Any Q			19	30	
^t PHL	Data	Anya	$C_1 = 15 pF, R_1 = 2$	k0	13	20	ns
^t PLH	Address	Any Q	$C_L = 15 pF$, $R_L = 2$ See Note 3	K32,	17	27	
^t PHL	Address	Any C	See Note 3		14	20	ns
tPLH	Ğ	Any Q			15	24	
^t PHL	3	Any C			15	24	ns

tpLH = propagation delay time, low-to-high-level output

tpHL = propagation delay time, high-to-low-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



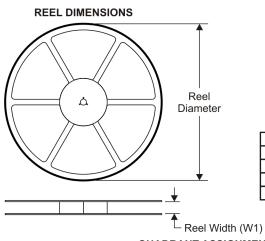
 $^{^{\}ddagger}$ All typical values are at V_{CC} = 5 V, T_{A} = 25°C.

 $[\]S$ Not more than one output should be shorted at a time, and duration short-circuit should not exceed one second.

NOTE 2: $I_{\mbox{\footnotesize{CC}}}$ is measured with the inputs grounded and the outputs open.



TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device		Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS259BDR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS259BNSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1





*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS259BDR	SOIC	D	16	2500	333.2	345.9	28.6
SN74LS259BNSR	SO	NS	16	2000	346.0	346.0	33.0

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